

FSX017LG

Super Low Noise HEMT

FEATURES

- Medium Power Output : P1dB=16.0dBm (Typ.)@f=12.0GHz
- High Power Gain: G1dB=8.0dB (Typ.)@f=12.0GHz
- · Proven Reliability
- Cost Effective Harmetic Microstrip Package
- · Tape and Reel Available

DESCRIPTION

The FSX017LG is a general purpose GaAs FET designed for medium power applications up to 12GHz. These devices have a wide dynamic range and are suitable for use in medium power, wide band, linear drive amplifiers.

Sumitomo Electric stringent Quality Assurance Program assures the highest reliability and consistent performance.



ABSOLUTE MAXIMUM RATING (Ambient Temperature Ta=25 deg.C)

| Item | Symbol | Condition | Rating | Unit |
|-------------------------|-----------------|-----------|-------------|-------|
| Drain-Source Voltage | V _{DS} | | 8 | V |
| Gate-Source Voltage | V _{GS} | | -5.0 | V |
| Total Power Dissipation | Ptot | Note | 220 | mW |
| Storage Temperature | Tstg | | -65 to +175 | deg.C |
| Channel Temperature | Tch | | 175 | deg.C |

Note: Mounted on AI_2O_3 board (30 x 30 x 0.65mm)

Sumitomo Electric recommends the following conditions for the reliable operation of GaAs FETs:

- 1. The drain-source operating voltage (V_{DS}) should not exceed 4 volts.
- 2. The forward and reverse gate currents should not exceed 0.7 and -0.1 mA respectively with gate resistance of 2000ohm.

ELECTRICAL CHARACTERISTICS (Ambient Temperature Ta=25 deg.C)

| 140.00 | Symbol | Condition | Limit | | | 11 | |
|-------------------------------|------------------|---------------------------------|-------|------|------|---------|--|
| nem | Symbol | Condition | Min. | Тур. | Max. | Unit | |
| Saturated Drain Current | I _{DSS} | $V_{DS} = 3V, V_{GS} = 0V$ | 35 | 55 | 75 | mA | |
| Transconductance | g _m | $V_{DS} = 3V$, $I_{DS} = 27mA$ | - | 50 | - | mS | |
| Pinch-off Voltage | Vp | $V_{DS} = 3V, I_{DS} = 2.7mA$ | -0.7 | -1.2 | -1.7 | V | |
| Gate Source Breakdown Voltage | V _{GSO} | I _{GS} = -2.7uA | -5.0 | - | - | V | |
| Power Gain at 1dB G.C.P. | P1dB | $V_{DS} = 4V, I_{DS} = 30mA,$ | 15.0 | 16.0 | - | dBm | |
| Power Gain at 1dB G.C.P. | G1dB | f = 12 GHz | 7.0 | 8.0 | - | dB | |
| Thermal Resistance | R _{th} | Channel to Case | - | 300 | 400 | deg.C/W | |

CASE STYLE LG

G.C.P.:Gain Compression Point

Note: The RF parameters are measured on a lot basis by sample testing at an AQL=0.1% Level- II inspection. Any lot failure shall be 100% retested.

| Lot qty. | | | Sample qty. | Accept/Reject |
|----------|------|-------|-------------|---------------|
| 1200 | or | less | 125 | (0,1) |
| 1201 | to | 3200 | 200 | (0,1) |
| 3201 | to | 10000 | 315 | (1,2) |
| 10001 | or | over | 500 | (1,2) |
| RoHS Com | plia | nce | Yes | |

ESD Class 1A Note : Based on JEDEC JESD22-A114 (C=100pF, R=1.5kohm)



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SUMITOMO ELECTRIC

DRAIN CURRENT vs DRAIN-SOURCE VOLTAGE

FSX017LG



POWER DERATING CURVE

OUTPUT POWER vs. INPUT POWER







S-PARAMETERS Vds=4V,IDS=30mA

| FREQUENCY | Su | | S21 | | S12 | | S22 | |
|-----------|------|---------|---------|---------|------|---------|------|---------|
| (MHz) | MAG | ANG | MAG | ANG | MAG | ANG | MAG | ANG |
| 500 | .992 | - 15.5 | 4.814 | 165.8 | .012 | 78.8 | .735 | - 95 |
| 2000 | .915 | - 58.9 | 4.244 | 127.5 | .039 | 51.8 | .709 | - 35.8 |
| 4000 | .795 | - 104.8 | 3.300 | 86.9 | .053 | 24.1 | .670 | - 60.0 |
| 6000 | .690 | - 144.0 | 2.839 | 54.1 | .054 | 6.4 | .632 | - 74 7 |
| 8000 | .606 | 167.3 | 2.542 | 18.1 | .052 | - 13.4 | .533 | - 95.2 |
| 10000 | .628 | 130.0 | 2.237 | 16.3 | .052 | - 16.5 | .484 | - 133.0 |
| 12000 | .655 | 98.8 | 1.924 | - 51.0 | .067 | - 33.2 | .544 | - 173.9 |
| 14000 | .658 | 70.8 | 1.633 | - 82.5 | .075 | - 51.9 | .594 | 158.0 |
| 16000 | .630 | 44.8 | 1.466 - | - 113.5 | .085 | - 75.4 | .650 | 134 1 |
| 18000 | .570 | 14.0 | 1.394 - | - 147.7 | .096 | - 107.7 | .648 | 109.1 |
| 20000 | .513 | - 18.3 | 1.296 | 172.6 | .112 | - 151.6 | .619 | 68.1 |



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FSX017LG

LG PKG OUTLINE





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CAUTION

This product contains **gallium arsenide (GaAs)** which can be hazardous to the human body and the environment. For safety, observe the following procedures:

-Do not put these products into the mouth.

• Do not alter the form of this product into a gas, powder, or liquid through burning, crushing, or chemical processing as these by-products are dangerous to the human body if inhaled, ingested, or swallowed.

•Observe government laws and company regulations when discarding this product. This product must be discarded in accordance with methods specified by applicable hazardous waste procedures.

